

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT																								
NATURE OF CONVEYANCE:	ASSIGNMENT																								
CONVEYING PARTY DATA																									
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<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;">Name:</td> <td>Korean Institute of Machinery & Materials</td> </tr> <tr> <td>Street Address:</td> <td>171, Jang-Dong, Yuseong-gu,</td> </tr> <tr> <td>City:</td> <td>Daejeon-si</td> </tr> <tr> <td>State/Country:</td> <td>REPUBLIC OF KOREA</td> </tr> </table>		Name:	Korean Institute of Machinery & Materials	Street Address:	171, Jang-Dong, Yuseong-gu,	City:	Daejeon-si	State/Country:	REPUBLIC OF KOREA																
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CORRESPONDENCE DATA																									
<p>Fax Number: (202)955-5564</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 2029553000</p> <p>Email: don.monin@hklaw.com</p> <p>Correspondent Name: Donald L. Monin, Jr</p> <p>Address Line 1: 2099 Pennsylvania Avenue N.W.</p>																									

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ATTORNEY DOCKET NUMBER:	118973-05005
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NAME OF SUBMITTER:	Donald L. Monin, Jr.
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<p>Total Attachments: 3 source=118973_05005_Executed Assignment_CIP#page1.tif source=118973_05005_Executed Assignment_CIP#page2.tif source=118973_05005_Executed Assignment_CIP#page3.tif</p>

ASSIGNMENT

WHEREAS we, the below named inventors, [hereinafter referred to as Assignors], have made an invention entitled:

METHOD AND APPARATUS FOR MANUFACTURING ELECTRONIC DEVICE USING ROLL-TO-ROLL ROTARY PRESSING PROCESS

for which we executed an application for United States Letters Patent concurrently herewith; or filed an application for United States Letters Patent on _____, (Application No. _____); and

WHEREAS, Korean Institute of Machinery & Materials, a corporation of Republic of Korea, whose post office address is 171, Jang-Dong, Yuseong-gu, Daejeon-si, Republic of Korea, (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to issue upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, we, as assignors, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, our entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and we hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, WE HEREBY further covenant and agree that we will, without further consideration, communicate with assignee, its successors and assigns, any facts known to us respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

AND, WE HEREBY authorize and request the attorneys we have empowered in the Declaration and Power of Attorney in this application, to insert here in parenthesis (Application No. _____, filed _____) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, we have hereunto set our hands.

Full Name of First Assignor BYUNG-OH CHOI	Assignor's Signature <i>Byung-oh Choi</i>	Date May 29, 2009
Address: 102-1205, Expo APT, Jeonmin-dong, Yuseong-gu, Daejeon-si, Korea		Citizenship Republic of Korea

Names of additional inventors attached ☒ Yes ☐ No

Full Name of Second Assignor BYUNG-SOON RYU	Assignor's Signature <i>Byung Soon, Ryu</i>	Date May 29, 2009
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Full Name of Third Assignor KYU-JIN LIM	Assignor's Signature <i>Kyu-jin, Lim</i>	Date May 29, 2009
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Full Name of Fourth Assignor KWANG-YOUNG KIM	Assignor's Signature <i>Kwang Young Kim</i>	Date May 29, 2009
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Full Name of Fifth Assignor DONG-SOO KIM	Assignor's Signature <i>Kim Dong Soo</i>	Date May 29, 2009
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Full Name of Sixth Assignor SO-NAM YUN	Assignor's Signature <i>So Nam Yun</i>	Date May 29, 2009
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Full Name of Seventh Assignor YOUNG-BOG HAM	Assignor's Signature <i>Young Bog Ham</i>	Date May 29, 2009
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Full Name of Eighth Assignor TAIK-MIN LEE	Assignor's Signature <i>Taik Min Lee</i>	Date May 29, 2009
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Names of additional inventors attached ☒ Yes ☐ No

Full Name of Ninth Assignor JEONG-DAI JO	Assignor's Signature <i>Jeong-dai Jo</i>	Date May 29, 2009
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Full Name of Tenth Assignor HYUN-EUI LIM	Assignor's Signature <i>Hyun-Eui Lim</i>	Date May 29, 2009
Address: 108-401, Worldcupfamily APT, Jangdae-dong, Yuseong-gu, Daejeon-si, Korea		Citizenship Republic of Korea

Full Name of Eleventh Assignor CHAN-SU YOO	Assignor's Signature <i>chan su yoo</i>	Date May 29, 2009
Address: 204-403, Expo APT, Jeonmin-dong, Yuseong-gu, Daejeon-si, Korea		Citizenship Republic of Korea

Names of additional inventors attached ☐ Yes ☒ No

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